

Electrical Characterization of Semiconductors



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Relaxation: trap filling and emptying timesTransient (spectroscopy)



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Basic Kinetics

A "trap" is a deep level, localized in space. Difficult to get the charge out of there long relaxation time



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Trap "thermalization time" is increasing with

- $E_{\rm T}$ (level depth, $E_{\rm a}$)
- *T* (temperature) mid-gap levels in silicon are already slow, so in polymers forget fast electronics!

 $1/\tau = e_{\rm p} = \gamma T^2 \sigma \exp(-E_{\rm a}/kT)$

Capacitance Transfents

"Change the bias and let's look how the capacitance evolves over time"

Capacitance depends on bias (remember, something like C~1/V^{1/2})
A new depletion width has to be reached. At the end:

 $C = \varepsilon A/W$

- For shallow levels: response is immediate. Limited only by speed at which free carriers can move out (μ_p) .
- For deep levels: the charges have to come off there first.

Example: deep acceptor



- 1. Free holes move out of interface region. Immediate increase of $W(C\downarrow)$
- 2. This creates a region where the deep levels are off-equilibrium
- 3. Charges are slowly emitted from the deep levels there
 - higher space-charge density

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- less depletion width is needed to reach condition $f f_0^W \rho(x) d^2 x = V_{bb}$
- 4. W slowly shrinks again a little. Increased capacitance

Transient



Summary: 1) Free carriers move out 2) Region off-equilibrium 3) Deep levels empty

$$1/\tau = e_{\rm p} = \gamma T^2 \sigma \exp(-E_{\rm a}/kT)$$



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Monitoring τ over temperature will give us E_a

Very sensitive and very accurate!

Minority Traps

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- A "minority trap" communicates with the minority band
- Under bias, the minority Fermi level moves in opposite direction
- This time electrons are emitted and the space charge decreases
- Slowly increasing W and decreasing C over time

Example of C-transients:



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$$1/\tau = e_{\rm p} = \gamma T^2 \sigma \, \exp(-E_{\rm a}/kT)$$

MEH-PPV on Silicon2 minority traps: a, c1 majority trap: b



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DLTS (deep-level transient-spectroscopy)

Of the entire set of data, take only two points, at t₁ and t₂
The DLTS signal is then S = C(t₁)-C(t₂)

For low-T: $\tau = 0$, $C(t_1) = C(t_2)$: S = 0For high-T: $\tau = 0$, $C(t_1) = C(t_2)$: S = 0

Maximum when: $\tau_0 T^{-2} \exp(E_a/kT) = (t_2 - t_1)/[\ln(t_1/t_2)]$



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Two scans, with different time window (t_1, t_2) will yield E_a

DLTS SUMMARY

DLTS is

- Very easy to perform. "Walk-away" measurements
- Sensitive

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- Reliable data with acurate energy determination
- "Fingerprint" spectra of defects
- Can determine density of defects. $\Delta C/C = N_T/2(N_A-N_D)$

Modern improvement Laplace DLTS :

- Use entire transient in analysis
 - Higher sensitivity
 - Higher resolution
- Made possible by abundance of cheap computing power (can be done even on-line)



TSC (thermally stimulated current)

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"Cool down the sample under (forward) bias and warm up without"



a) 0V, RT, thermal equilibrium
b) Forward bias, RT, thermal equilibrium cool down, remove bias
c) Zero bias, 77 K, no-equilibrium
d) Warm up, charges are emitted; external current until all levels are empty. *I* back to 0 . We see a peak in I

TSG

Position of the peak $T_{\rm m}$ depends on the scanning speed $\beta = dT/dt$: fast scan: the levels have no time to empty. high $T_{\rm m}$ slow scan: low $T_{\rm m}$ Example: $\ln (T_{\rm m}^{4}/\beta) = E_{\rm a}/kT_{\rm m} + C$ 19.6



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I is negative: holes move towards p-side of junction which is equivalent to reverse current

19.4

 $Ln \ (T_m{}^4/\beta)$ 19.2 19.0 18.8 18.6 18.4

Integral f I dt is constant is independent of scanning speed and reveals the deep level density

3.60 3.65 3.70 3.75 3.80 3.85

1000/Tm (1/K)

Experimental Set-up

Measurement of capacitance and conductance:
Apply a sign-voltage and observe what current results
Everything "in-phase" is conductance, "out-of-phase" is capacitance

 $V = V \sin(\omega t)$

 $I = G V \sin(\omega t)$ (R) $I = \omega C V \cos(\omega t)$ (C)

Lock-in detection (or phase-sensitive detection) to decompose the current into in-phase and out-of phase parts

Phase-sensitive Detection

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PSD example

Home-built RCL bridge Based on Stanford SR830 1 mHz - 3 kHz

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Commercial RCL bridge Fluke 6306 100 Hz - 1 MHz

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Summary of Fleetrieal Measurements									
	Device	Shallow	Shallow	Deep	Deep level	Free	Conduc-	Interface	Difficulty
	Structure	Level	Lelvel	level	density	carrier	tion	states	cost
		position	density	position		mobility	Model		
IV	Schoottky Bulk	+	+				++		1
CV	Schottky								2
	p-n		++						3
Admittance	Schottky	++							
Spectroscopy	P-n								4
IV	FET					++			2
Hall	Bulk					++			8
TSC	Schottky P-n			+	++			+	3
DLIS	Schottky P-n			++	+			+	5
ToF	bulk					++			8

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